

BB02-GA :- 2.00mm (0.079") SOCKET, QUAD ROW, STRAIGHT, THROUGH HOLE TYPE, 08 TO 120 CONTACTS

SPECIFICATIONS :

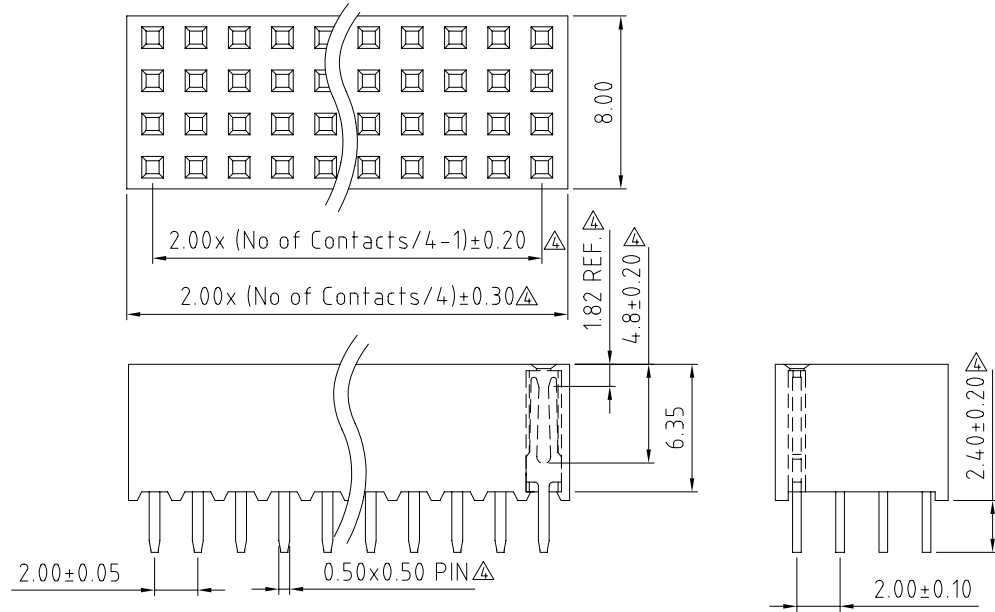
CURRENT RATING	2 AMP
INSULATOR RESISTANCE	1000 MEGOHMS MIN.
CONTACT RESISTANCE	20 MOHM MAX.
DIELECTRIC WITHSTANDING	AC 500 V
OPERATING TEMPERATURE	-40°C TO +105°C
CONTACT MATERIAL	PHOSPHOR BRONZE
INSULATOR MATERIAL	THERMOPLASTIC, UL 94V-0
	STANDARD : NYLON 6T
PLATING	GOLD, TIN, OR SELECTIVE OVER 30~50U" NICKEL
SOLDERABILITY	IR REFLOW: 260°C FOR 10 SEC
	WAVE: 230°C FOR 5-10 SEC
	MANUAL SOLDER: 350°C FOR 3-5 SEC

PACKED LOOSE IN TRAY Δ

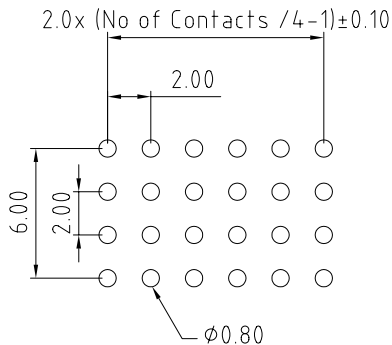
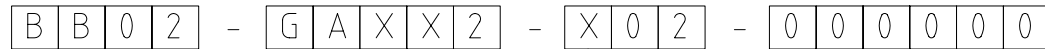
MATES WITH :- BB02-FM

NOTES:

1. RECOMMENDED MATING PIN LENGTH: 3.5MM-4.0MM Δ



HOW TO ORDER



RECOMMENDED PC BOARD HOLE LAYOUT
(TOLERANCE: ± 0.05)

NO. OF CONTACTS

- 08 TO 96
- 100 = 00
- 104 = 04
- 108 = 08
- 112 = A2
- 116 = A6
- 120 = B0

CONTACT PLATING OPTIONS

- K = GOLD FLASH (STANDARD)
- A = 10U" GOLD ON CONTACT/GOLD FLASH ON TAIL
- B = 15U" GOLD ON CONTACT/GOLD FLASH ON TAIL
- C = 30U" GOLD ON CONTACT/GOLD FLASH ON TAIL
- T = BRIGHT TIN
- M = MATT TIN
- D = GOLD FLASH ON CONTACT/BRIGHT TIN ON TAIL
- E = 10U" GOLD ON CONTACT/BRIGHT TIN ON TAIL
- F = 15U" GOLD ON CONTACT/BRIGHT TIN ON TAIL
- G = 30U" GOLD ON CONTACT/BRIGHT TIN ON TAIL

10. 15/05/03 - NUR RELEASE
11. 29/03/05 - NYW
12. 09/08/06 - NYW
13. 03/06/08 - CHC
14. 12/09/08 - NYW
15. 21/01/09 - CHC
16. 06/11/09 - NYW

Scale: 4:1	THIRD ANGLE	Unstated Tolerances: X. ± 0.30 XX ± 0.25 .XX ± 0.15 .XXX ± 0.10	Material SEE NOTE
Drawn: CHC			
App'd: XXXX	Title QUAD ROW SOCKET		NOT TO SCALE
Date: 6 NOV '09	Revision: 1.6		Unit: mm

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Type: BB02-GA
BB02-GA
Drawing Number:
Sheet 1 of 1
Drawing E and O E